iC-LFM

64x1 LINEAR IMAGE SENSOR



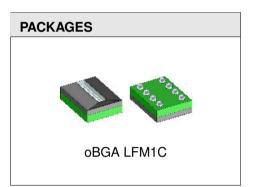
Rev A1, Page 1/9

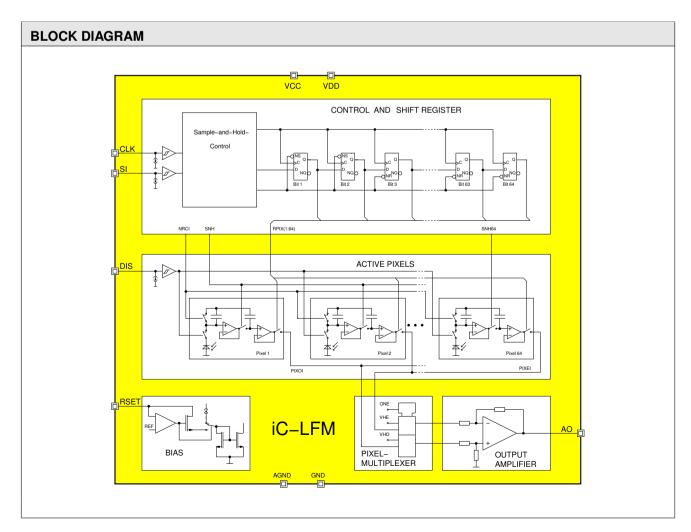
FEATURES

- ♦ 64 active photo pixels of 56 µm at a pitch of 63.5 µm (400 DPI)
- ♦ Integrating L-V conversion followed by a sample & hold circuit
- ♦ High sensitivity and uniformity over wavelength
- ♦ High clock rates of up to 5 MHz
- ♦ Only 64 clocks required for readout
- ♦ Shutter function enables flexible integration times
- ♦ Glitch-free analogue output
- ♦ Push-pull output amplifier
- ♦ 5 V single supply operation

APPLICATIONS

- ♦ Optical line sensors
- ♦ CCD substitute





Copyright © 2015 iC-Haus http://www.ichaus.com



Rev A1, Page 2/9

DESCRIPTION

iC-LFM is an integrating light-to-voltage converter with a single line of 64 pixels pitched at 63.5 μm (center-to-center distance). Each pixel consists of a 56.4 μm x 200 μm photodiode, an integration capacitor and a sample and hold circuit.

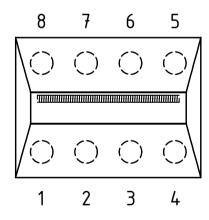
The integrated control logic makes operation very simple, with only a start and clock signal necessary. A third control input enables the integration period to be paused at any time (electronic shutter).

With the start signal the hold mode is activated for all pixels simultaneously with the next rising clock edge; starting with pixel 1 the hold voltages are switched in sequence to the push-pull output amplifier. The second clock pulse deletes all integration capacitors and the integration period starts again in the background during the output phase. A run is complete after 64 clock pulses.

iC-LFM is suitable for high clock rates of up to 5 MHz. If this is not required the supply current can be reduced via the external bias setting.

PACKAGING INFORMATION oBGA LFM1C

PIN CONFIGURATION oBGA LFM1C



PIN FUNCTIONS

No.	Name	Function

1	SI	Start Integration Input
2	CLK	Clock Input
3	AO	Analogue Output
4	VCC	+5 V Supply Voltage
5	RSET	Bias Current (connected to GND for in-
		ternal bias = default; resistor from VCC
		to RSET for reduced current consump-
		tion)
6	AGND	Analogue Ground
7	GND	Digital Ground
8	DIS	Global Shutter



Rev A1, Page 3/9

ABSOLUTE MAXIMUM RATINGS

Beyond these values damage may occur; device operation is not guaranteed.

Item	Symbol	Parameter	Conditions			Unit
No.				Min.	Max.	
G001	VDD	Digital Supply Voltage		-0.3	6	V
G002	VCC	Analogue Supply Voltage		-0.3	6	V
G003	V()	Voltage at SI, CLK, DIS, RSET, AO		-0.3	VCC + 0.3	V
G004	I()	Current in RSET, AO		-10	10	mA
G005	Vd()	ESD Susceptibility at all pins	HBM, 100 pF/1.5 kΩ		4	kV
G006	Tj	Operating Junction Temperature		-40	125	°C

THERMAL DATA

Operating Conditions: VCC = VDD = 5 V ±10%

Item	Symbol	Parameter	Conditions				Unit
No.				Min.	Тур.	Max.	
T01	Ta	Operating Ambient Temperature Range	see package specification oBGA™ LFM1C				



Rev A1, Page 4/9

ELECTRICAL CHARACTERISTICS

Operating Conditions: $VCC = VDD = 5 V \pm 10\%$, RSET = GND, Tj = -25...85 °C unless otherwise noted

Item No.	Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Total I	Device						
001	VDD	Digital Supply Voltage Range		4.5		5.5	V
002	VCC	Analogue Supply Voltage Range		4.5		5.5	V
003	I(VDD)	Supply Current in VDD	f(CLK) = 1 MHz		200	300	μΑ
004	I(VCC)	Supply Current in VCC		2		7	mA
005	Vc()hi	Clamp Voltage hi at SI, CLK, DIS, RSET	Vc()hi = V() - VCC; I() = 1 mA	0.3		1.8	V
006	Vc()lo	Clamp Voltage lo at SI, CLK, DIS, RSET	Vc()hi = V() - V(AGND); I() = -1 mA	-1.5		0.3	V
007	Vc()hi	Clamp Voltage hi at AO	Vc()hi = V(AO) - VCC; I(AO) = 1 mA	0.3		1.5	V
800	Vc()lo	Clamp Voltage lo at AO, VCC, VDD, GND	Vc()lo = V() - V(AGND); I() = -1 mA	-1.5		-0.3	V
Photo	diode Array	y					
201	A()	Radiant Sensitive Area	200 μm x 56.40 μm per Pixel		0.01128		mm ²
202	$S(\lambda)$ max	Spectral Sensitivity	λ = 680 nm (see Fig. 1)		0.5		A/W
203	λ_{ar}	Spectral Application Range	$S(\lambda_{ar}) = 0.25 \times S(\lambda) \text{max (see Fig. 1)}$	400		980	nm
Analo	gue Output	AO					
301	Vs()lo	Saturation Voltage lo	I() = 1 mA			0.5	V
302	Vs()hi	Saturation Voltage hi	Vs()hi = VCC - V(), I() = -1 mA			1	V
303	K	Sensitivity	λ = 680 nm		2.88		V/pWs
304	V0()	Offset Voltage	integration time 1 ms, no illumination		400	800	mV
305	ΔV0()	Offset Voltage Deviation during integration mode	$\Delta V0() = V(AO)t1 - V(AO)t2,$ $\Delta t = t2 - t1 = 1 \text{ ms}$	-250		50	mV
306	ΔV()	Signal Deviation during hold mode	$\Delta V0() = V(AO)t1 - V(AO)t2,$ $\Delta t = t2 - t1 = 1 \text{ ms}$	-150		150	mV
307	tp(CLK- AO)	Settling Time	CI(AO) = 10 pF, $CLK Io \rightarrow hi until V(AO) = 0.98 \times V(VCC)$			200	ns
Power	-On-Reset						
801	VCCon	Power-On Release by VCC				4.4	V
802	VCCoff	Power-Down Reset by VCC		1			V
803	VCChys	Hysteresis	VCChys = VCCon — VCCoff	0.4	1	2	V
Bias (Current Adj	ust RSET					
901	Ibias()	Permissible External Bias Current		20		100	μΑ
902	Vref	Reference Voltage	I(RSET) = Ibias	2.5	3	3.5	V
Input	Interface SI	, CLK, DIS					
B01	Vt()hi	Threshold Voltage hi				2	V
B02	Vt()lo	Threshold Voltage lo		0.8			V
B03	Vt()hys	Hysteresis	Vt()hys = Vt()hi - Vt()lo	100		250	mV
B04	I()	Pull-Down Current		10	30	50	μΑ
B05	fclk	Permissible Clock Frequency				5	MHz

Rev A1, Page 5/9

OPTICAL CHARACTERISTICS: Diagrams

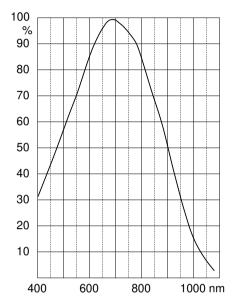


Figure 1: Relative spectral sensitivity

OPERATING REQUIREMENTS: Logic

Operating Conditions: VCC = VDD = 5 V $\pm 10\%$, Tj = -25...85 °C input levels lo = 0...0.45 V, hi = 2.4 V...VCC, see Fig. 2 for reference levels

Item	Symbol	Parameter	Conditions			Unit
No.				Min.	Max.	
1001	tset	Setup Time: SI stable before CLK lo \rightarrow hi	see Fig. 3	50		ns
1002		Hold Time: SI stable after CLK lo \rightarrow hi	see Fig. 3	50		ns

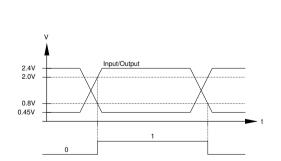


Figure 2: Reference levels

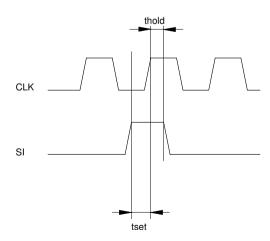


Figure 3: Timing diagram



Rev A1, Page 6/9

DESCRIPTION OF FUNCTIONS

Normal operation

Following an internal power-on reset the integration and hold capacitors are discharged and the sample and hold circuit is set to sample mode. A high signal at SI and a rising edge at CLK triggers a readout cycle and with it a new integration cycle.

In this process the hold capacitors of pixels 1 to 63 are switched to hold mode immediately (SNH = 1), with

pixel 64 (SNH64 = 1) following suit one clock pulse later. This special procedure allows all pixels to be read out with just 64 clock pulses. The integration capacitors are discharged by a one clock long reset signal (NRCI = 0) which occurs between the 2^{nd} and 3^{rd} falling edge of the readout clock pulse (cf. Figure 4). After the 63 pixels have been read out these are again set to sample mode (SNH = 0), likewise for pixel 64 one clock pulse later (SNH64 = 0).

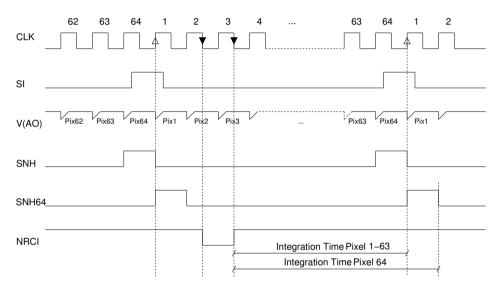


Figure 4: Readout cycle and integration sequence

If prior to the 64th clock pulse a high signal occurs at SI the present readout is halted and immediately re-initiated with pixel 1. In this instance the hold ca-

pacitors retain their old value i.e. hold mode prevails (SNH/SNH64 = 0).

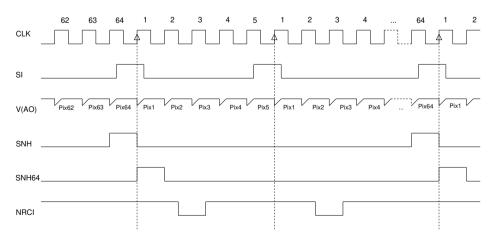


Figure 5: Restarting a readout cycle

With more than 64 clock pulses until the next SI signal, pixel 1 is output without entering hold mode; the out-

put voltage tracks the voltage of the pixel 1 integration capacitor.



Rev A1, Page 7/9

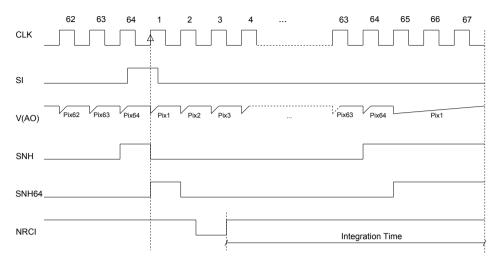


Figure 6: Clock pulse continued without giving a new integration start signal

Operation with the shutter function

Integration can be halted at any time via pin DIS, i.e. the photodiodes are disconnected from their corresponding integration capacitor when DIS is high and

the current integration capacitor voltages are maintained. If this pin is open or switched to GND the pixel photocurrents are summed up by the integration capacitors until the next successive SI signal follows.

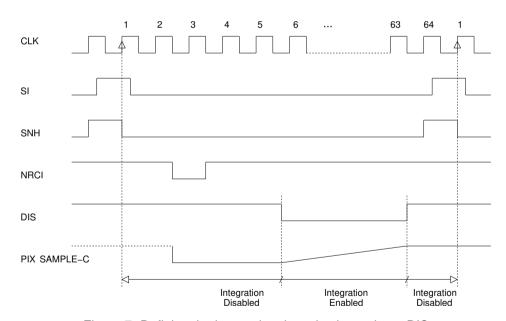


Figure 7: Defining the integration time via shutter input DIS

External bias current setting

In order to reduce the power consumption of the device an external reference current can be supplied to pin RSET which reduces the maximum readout frequency, however. To this end a resistor must be connected from VCC to RSET. If this pin is not used, it should be connected to GND.



Rev A1, Page 8/9

iC-Haus expressly reserves the right to change its products and/or specifications. An info letter gives details as to any amendments and additions made to the relevant current specifications on our internet website www.ichaus.com/infoletter; this letter is generated automatically and shall be sent to registered users by email.

Copying - even as an excerpt - is only permitted with iC-Haus' approval in writing and precise reference to source.

iC-Haus does not warrant the accuracy, completeness or timeliness of the specification and does not assume liability for any errors or omissions in these materials.

The data specified is intended solely for the purpose of product description. No representations or warranties, either express or implied, of merchantability, fitness for a particular purpose or of any other nature are made hereunder with respect to information/specification or the products to which information refers and no guarantee with respect to compliance to the intended use is given. In particular, this also applies to the stated possible applications or areas of applications of the product.

iC-Haus products are not designed for and must not be used in connection with any applications where the failure of such products would reasonably be expected to result in significant personal injury or death (Safety-Critical Applications) without iC-Haus' specific written consent. Safety-Critical Applications include, without limitation, life support devices and systems. iC-Haus products are not designed nor intended for use in military or aerospace applications or environments or in automotive applications unless specifically designated for such use by iC-Haus.

iC-Haus conveys no patent, copyright, mask work right or other trade mark right to this product. iC-Haus assumes no liability for any patent and/or other trade mark rights of a third party resulting from processing or handling of the product and/or any other use of the product.



Rev A1, Page 9/9

ORDERING INFORMATION

Туре	Package	Order Designation
iC-LFM	oBGA™ LFM1C	iC-LFM oBGA LFM1C

For technical support, information about prices and terms of delivery please contact:

iC-Haus GmbH Tel.: +49 (0) 61 35 - 92 92 - 0
Am Kuemmerling 18 Fax: +49 (0) 61 35 - 92 92 - 192
D-55294 Bodenheim Web: http://www.ichaus.com
GERMANY E-Mail: sales@ichaus.com

Appointed local distributors: http://www.ichaus.com/sales_partners